

# Water-based Low Solids Wave Soldering Flux

## JS-3000V-II

### ■ Feature

1. Very low residue flux and excellent reliability, chemically and electrically stable under a variety of operating environments, and require no cleaning after soldering.
2. Excellent solderability as RA type flux.
3. Suitable for both leaded and surface mount components.

### ■ Specifications

Type of solvent	Water base, low VOC	
Appearance	Colorless clear liquid	
Specific gravity	(20°C)	1.00
Solids content	(%)	2.8
Halide content	(%)	0
Copper plate corrosion test	Passed	
Copper mirror corrosion test	Passed	
Surface insulation resistance (Ω)	Initial value	$> 1 \times 10^{13}$
	After humidification	$> 1 \times 10^{12}$
Aqueous solution resistivity	(Ωcm)	$> 5 \times 10^4$
Solder spreadability	(%)	$> 80$
Application method	Spray	
Features	<ul style="list-style-type: none"><li>• Very low residue.</li><li>• Excellent solderability.</li><li>• Contains only 5% of alcohol</li></ul>	

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